



30A TRENCH SCHOTTKY RECTIFIER

Product Summary

SDT30B100D1

V _{RRM} (V)	I _O (A)	V _{F (MAX)} (V) @ +25°C	I _{R (MAX)} (μΑ) @ +25°C		
100	30	0.85	120		

Features and Benefits

- Low Forward Voltage Drop
- **Excellent High Temperature Stability**
- Soft, Fast Switching Capability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/guality/product-definitions/

Description and Applications

The SDT30B100D1 provides very low VF and extremely excellent reverse leakage stability at high temperatures. It is ideal for use as a rectifier, freewheel diode or blocking diode in:

- **DC-DC Converters**
- **AC-DC Adaptors**

Mechanical Data

- Case: TO252
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (63)
- Polarity: See Below
- Weight: 0.317 grams (Approximate)



TO252 (DPAK) (Type TH)

Top View

Package Pin Out Configuration

Ordering Information (Note 4)

Case	Packaging
TO252 (DPAK) (Type TH)	2,500 pieces/reel

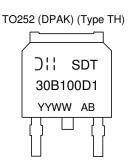
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information

Notes:



Dil = Manufacturer's Marking SDT30B100D1 = Product Type Marking Code AB = Foundry and Assembly Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 20 = 2020) WW = Week (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	Vrrm Vrwm Vrm	100	V
Average Rectified Output Current	lo	30	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	130	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 5)	Rejc	2	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	VF	 	0.48 0.40 0.56 0.51 0.78	0.54 0.46 0.62 0.57 0.85	v	IF = 5A, TJ = +25°C IF = 5A, TJ = +125°C IF = 10A, TJ = +25°C IF = 10A, TJ = +125°C IF = 30A, TJ = +25°C
		—	0.72	0.79		IF = 30A, TJ = +125°C
Leakage Current (Note 6)	I _R	_	12 5	120 20	μA mA	$ V_R = 100V, T_J = +25^{\circ}C \\ V_R = 100V, T_J = +125^{\circ}C $

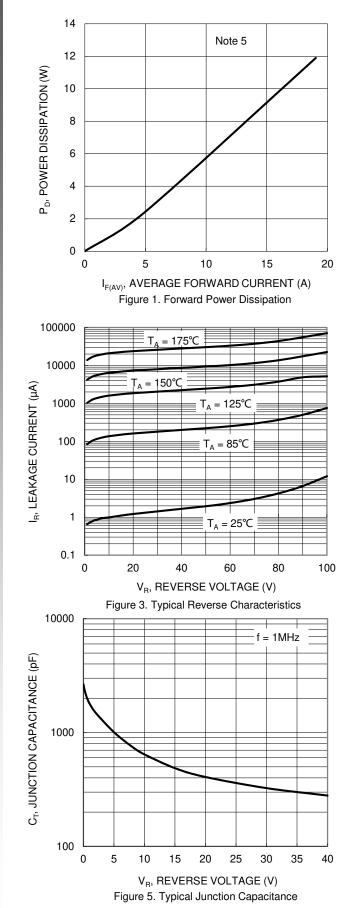
Notes: 5. Test with 2inch*2inch Al board + 50mm*50mm*23mm Al heatsink.

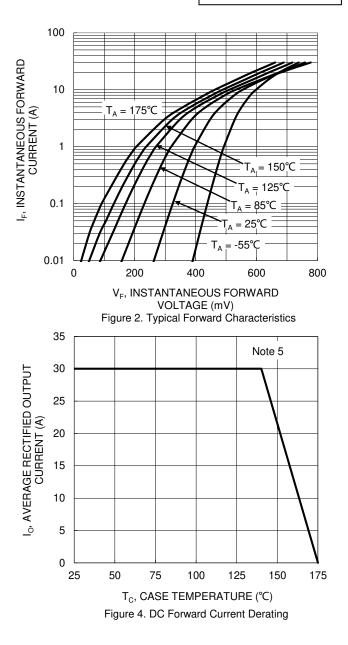
6. Short duration pulse test used to minimize self-heating effect.



SDT30B100D1

NEW PRODUCT







Package Outline Dimensions

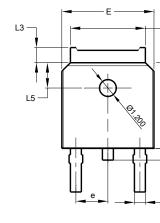
Please see http://www.diodes.com/package-outlines.html for the latest version.

b3

D

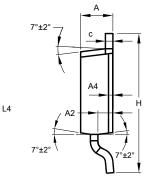
b(3x)

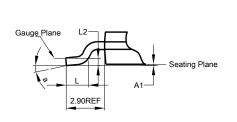
D1



F1

Ш





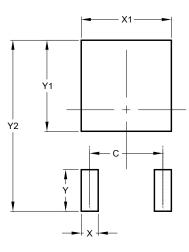
TO252 (DPAK) (Type TH)

	TO252 (DPAK) (Type TH)					
Dim	Min	Max	Тур			
Α	2.20	2.38	2.30			
A1	0.00	0.10	-			
A2	0.97	1.17	1.07			
A4	0.10 REF					
b	0.72	0.85	0.78			
b3	5.23	5.45	5.33			
С	0.47	0.58	0.53			
D	6.00 6.20 6.10					
D1	5.30 REF					
е	2.286 BSC					
E	6.50	6.70	6.60			
E1	4.70	4.92	4.83			
н	9.90	10.30	10.10			
L	1.40	1.70	1.60			
L2		0.51 BSC				
L3	0.90	1.25	-			
L4	0.60	1.00	0.80			
L5	1.70	1.90	1.80			
а	0°	8°	-			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK) (Type TH)



Dimensions	Value (in mm)
С	4.572
Х	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700



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